Report

16-AUG-2002 Rev O

BOX HEADER, 2.0 PITCH, RIGHT ANGLE, SMT TYPE.

1. INTRODUCTION

1.1. Purpose

Testing was performed on the BOX HEADER, 2.0 PITCH, RIGHT ANGLE, SMT TYPE to determine its conformance to the requirements of Product Specification 108-57250 Rev O.

1.2. Scope

This report covers the electrical, mechanical, and environmental performance of BOX HEADER, 2.0 PITCH, RIGHT ANGLE, SMT TYPE manufactured by the Global Personal Computer Division.

1.3. Conclusion

BOX HEADER, 2.0 PITCH, RIGHT ANGLE, SMT TYPE connector meets the electrical, mechanical, and environmental performance requirements of Product Specification 108-57250 Rev O.

1.4. Product Description

BOX HEADER, 2.0 PITCH, RIGHT ANGLE, SMT TYPE connector is designed for printed circuit board applications. The contacts are copper alloy, gold plated on the contact interface and tin-lead plating on the soldertail, all over nickel under-plated. The housing material is glass filled insulating polymer, UL94V-0.

1.5. Test Samples

The test samples were randomly selected from normal current production lots, and the following part numbers were used for test:

Test Group	Quantity	Description				
A, B, C, D, E, F, G, H	5 ea.	BOX HEADER, 2.0 PITCH, RIGHT ANGLE, SMT TYPE.				

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Oblic Hu	16-Aug-2002	Jerry Cheng	16-Aug-2002	Jebb Wu	16-Aug-2002
DR	DATE	CHK	DATE	APVD	DATE



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Taiwan Branch



1.6. Qualification Test Sequence

	Test Group							
Test or Examination	Α	В	С	D	Е	F	G	Н
	Test Sequence (a)							
Examination of Product	1,5	1,7	1,3	1,5	1,3	1,5	1,7	1,5
Contact Resistance	2,4	2,6		2,4		2,4	2,6	2,4
Insulation Resistance								
Dielectric Withstanding Voltage		3,5						
Mating Force							3	
Unmating Force							4	
Contact Retention Force							5	
Vibration								3
Humidit y		4						
Resistance to solder heat						3		
Salt Spray			2					
Thermal Shock	3							
Temperature Life				3				
Solderability					2			

Figure 1.

NOTE: (a) The numbers indicate sequence in which tests were performed.

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2. TEST RESULT

GP	TEST	SPEC.	DATA					
Ľ	1231	31 LO.	Mean	σ	Max.	Min.		
	Contact Resistance	20mΩ max.	6.63 mΩ		7.26 m Ω	$6.17~\text{m}\Omega$		
А	Thermal Shock	+85℃/ -55℃ , 5cycles	OK		ок	ОК		
	Contact Resistance	30mΩ max.	$7.19~\mathrm{m}\Omega$		8.95 m Ω	6.51 m Ω		
	Appearance	No Damage	OK		ок	OK		
	Insulation Resistance	5000M Ω min.	214.7ΤΩ		227.6ΤΩ	207.3ΤΩ		
	Dielectric Withstanding Voltage	500VAC for 1minute	ок		ок	ОК		
в	Humidity	90~95%,40℃± 2℃ for 96 hours.	OK		ок	OK		
╏╹	Dielectric Withstanding Voltage	500VAC for 1minute	OK		ОК	ОК		
	Insulation Resistance	5000M Ω min.	211.3ΤΩ		218.3ΤΩ	201.5ΤΩ		
	Appearance	No Damage	OK		ок	OK		
	Contact Resistance	20mΩ max.	6.40mΩ		7.66m Ω	6.05m Ω		
c	Salt Spray	35℃± 2℃ for 24 hours	OK		ок	OK		
٦	Contact Resistance	30mΩ max.	7.09 m Ω		9.81mΩ	6.35 m Ω		
	Appearance	No Damage	OK		ок	OK		
	Contact Resistance	20mΩ max.	$6.78~\mathrm{m}\Omega$		8.28m Ω	5.77 m Ω		
	Temperature Life	105± 3℃ for 250 hours	OK		ок	OK		
D	Contact Resistance	30mΩ max.	7.71 m Ω		9.96 m Ω	6.80m Ω		
	Appearance	No Damage	ОК		ОК	OK		
_	Solder ability	245± 5℃, 4~5sec	OK		ок	OK		
E	Appearance	No Damage	ОК		ОК	OK		
F	Contact Resistance	20mΩ max.	$5.38~\text{m}\Omega$		7.20 m Ω	4.17 m Ω		
	Resistance to solder heat	260± 5℃,10± 1sec	OK		ок	OK		
	Contact Resistance	30m Ω max.	6.84 mΩ		9.1mΩ	5.33 m Ω		
	Appearance	No Damage	ОК		ок	ОК		

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	Contact Resistance	20mΩ max.	5.38 mΩ		7.20 m Ω	4.17 m Ω
	Mating Force	200g Max. per pin.	6 8g		94g	55g
	Unmating Force	20g Min. per pin.	37		44g	31
G	Contact Retention Force	250gf Min Per Contact	494g		798g	364g
	Contact Resistance	30m Ω max.	10.21m Ω	-	12.33m Ω	58.46m Ω
	Appearance	No Damage	OK	-	OK	ОК
	Contact Resistance	20m Ω max.	6.91mΩ	-	8.62 m Ω	6.03 m Ω
н	Vibration	10-55-10 Hz/min, 3 axis/2 hours.	OK		ОК	ок
	Contact Resistance	30mΩ max.	8.26mΩ		9.53m Ω	7.09 m Ω
	Appearance	No Damage	OK		ОК	ок

Figure 2

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